MOSFET – P-Channel, Logic Level, POWERTRENCH[®]

FDG316P

General Description

This P-Channel Logic Level MOSFET is produced using ON Semiconductor's advanced POWERTRENCH process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- -1.6 A, -30 V
 - $R_{DS(ON)} = 0.19 \Omega @ V_{GS} = -10 V$
 - $R_{DS(ON)} = 0.30 \Omega @ V_{GS} = -4.5 V$
- Low Gate Charge (3.5 nC Typical)
- High Performance Trench Technology for Extremely Low RDS(ON)
- Compact Industry Standard SC70-6 Surface Mount Package
- These Devices are Pb-Free and are RoHS Compliant

Applications

- DC/DC Converter
- Load Switch
- Power Management

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

| Symbol | Parameter | Ratings | Units | |
|-----------------------------------|---|-------------------------------------|-------------|----|
| V _{DSS} | Drain-Source Voltage | | -30 | V |
| V _{GSS} | Gate-Source Voltage | | ±20 | V |
| I _D | Drain Current | ain Current Continuous (Note 1a) | | A |
| | Pulsed | | -6 | |
| PD | Power Dissipation for | (Note 1a) | 0.75 | W |
| | Single Operation | (Note 1b) | 0.48 | |
| T _J , T _{stg} | Operating and Storage Junction Temperature Range | | -55 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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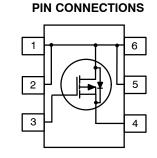
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MARKING DIAGRAM



36 = Specific Device Code = Assembly Operation Month

Μ



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

THERMAL CHARACTERISTICS

| Symbol | Parameter | Ratings | Unit |
|-----------------|---|---------|------|
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient (Note 1b) | 260 | °C/W |

1. R_{0.1A} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design. a) 170°C/W when mounted on a 1 in² pad of 2 oz copper.

b) 260°C/W when mounted on a minimum pad.

FDG316P

PACKAGE MARKING AND ORDERING INFORMATION

| Device Marking | Device | Reel Size | Tape Width | Shipping [†] |
|----------------|---------|-----------|------------|-----------------------|
| 36 | FDG316P | 7" | 8 mm | 3000 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Unit |
|--|--------------------------------------|--|-------------|----------------------|----------------------|-------|
| OFF CHARACT | ERISTICS | · | | | • | |
| BV _{DSS} | Drain to Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$ | -30 | - | - | V |
| $ \Delta BV_{DSS} / \Delta T_J \begin{array}{c} \text{Breakdown Voltage Temperature} \\ \text{Coefficient} \end{array} I_D = -250 \ \mu\text{A}, \ \text{Referenced} \end{array} $ | | $I_D = -250 \ \mu\text{A}$, Referenced to 25°C | - | -34 | - | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$ | - | - | -1 | μA |
| I _{GSS} | Gate-Body Leakage Forward | V_{GS} = 16 V, V_{DS} = 0 V | - | - | 100 | nA |
| I _{GSS} | Gate-Body Leakage Reverse | $V_{GS} = -16 \text{ V}, V_{DS} = 0 \text{ V}$ | - | - | -100 | nA |
| ON CHARACTE | RISTICS (Note 2) | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_D = -250 \ \mu A$ | -1 | -1.6 | -3 | V |
| $ \Delta V_{GS(th)} / \Delta T_J $ Gate Threshold Voltage $I_D = -250 \ \mu$ A, Reference Temperature Coefficient | | $I_D = -250 \ \mu\text{A}$, Referenced to 25°C | - | 3.5 | _ | mV/°C |
| R _{DS(on)} | Static Drain–Source On–Resistance | $ \begin{array}{l} V_{GS}=-10 \; V \! , I_{D}=-1.6 \; A \\ V_{GS}=-10 \; V \! , I_{D}=-1.6 \; A \! , T_{J}=125 ^{\circ} C \\ V_{GS}=-4.5 \; V \! , I_{D}=-1.3 \; A \end{array} $ | - - - | 0.16 0.22 0.23 | 0.19 0.31 0.30 | Ω |
| I _{D(on)} | On-State Drain Current | V_{GS} = -4.5 V, V_{DS} = -5 V | -3 | - | - | А |
| 9 _{FS} | Forward Transconductance | $V_{DS} = -5 \text{ V}, \text{ I}_{D} = -0.5 \text{ A}$ | - | 3 | - | S |
| DYNAMIC CHAI | RACTERISTICS | | | | | |
| C _{iss} | Input Capacitance | $V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$ | - | 165 | - | pF |
| C _{oss} | Output Capacitance | 1 | _ | 60 | - | pF |

SWITCHING CHARACTERISTICS (Note 2)

Reverse Transfer Capacitance

 C_{rss}

| t _{d(on)} | Turn-On Delay Time | $V_{DD} = -15 \text{ V}, \text{ I}_D = -1 \text{ A},$ $V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ | - | 8 | 20 | ns |
|---------------------|---------------------|---|---|-----|----|----|
| t _r | Turn-On Rise Time | $V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ | - | 9 | 20 | ns |
| t _{d(off)} | Turn-Off Delay Time | | - | 14 | 30 | ns |
| t _f | Turn-Off Fall Time | | - | 2 | 10 | ns |
| Qg | Total Gate Charge | $V_{DS} = -15 \text{ V}, \text{ I}_{D} = -1.6 \text{ A},$ $V_{GS} = -10 \text{ V}$ | - | 3.5 | 5 | nC |
| Q _{gs} | Gate-Source Charge | $V_{GS} = -10$ V | - | 0.6 | - | nC |
| Q _{gd} | Gate-Drain Charge | | - | 0.8 | - | nC |

25

pF

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

| ا _S | Maximum Continuous Drain-Source Diode Forward Current | | _ | _ | -0.42 | А |
|----------------|---|--|---|------|-------|---|
| V_{SD} | Drain–Source Diode Forward $V_{GS} = 0 V, I_S = -0.42 A$ (Note 2) Voltage | | - | 0.75 | -1.2 | V |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: Pulse Width < 300 µs, Duty Cycle < 2.0%

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TYPICAL PERFORMANCE CHARACTERISTICS

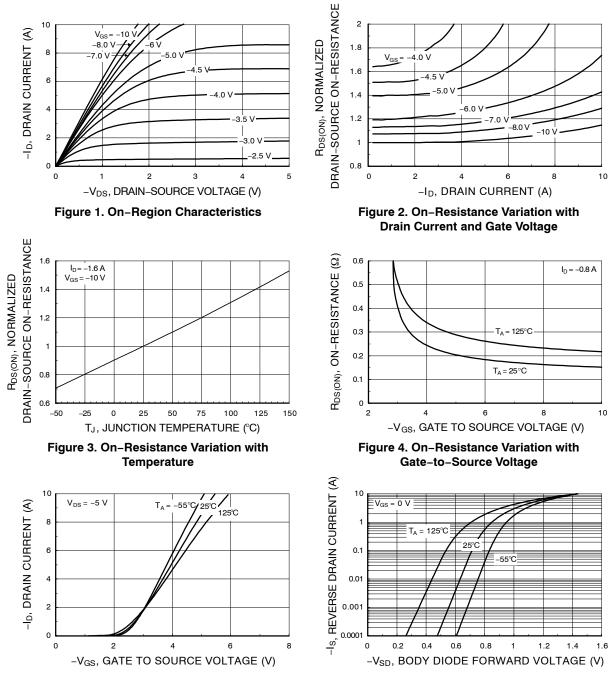
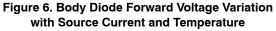


Figure 5. Transfer Characteristics



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TYPICAL PERFORMANCE CHARACTERISTICS (continued)

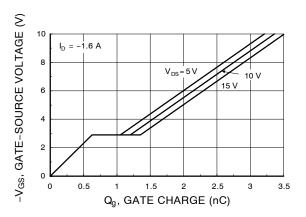


Figure 7. Gate Charge Characteristics

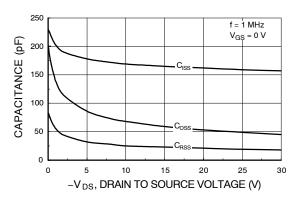


Figure 8. Capacitance Characteristics

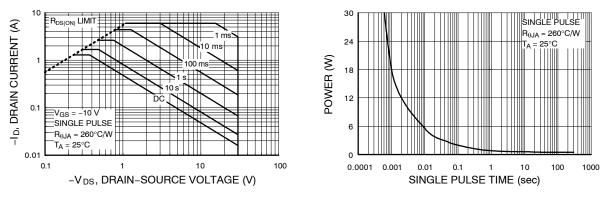
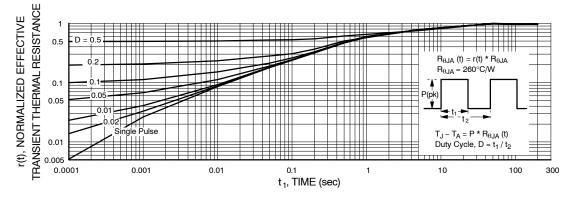


Figure 9. Maximum Safe Operating Area

Figure 10. Single Pulse Maximum Power Dissipation



Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.

Figure 11. Transient Thermal Response Curve

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0.043

0.004





- XXX = Specific Device Code

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering

details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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| STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2 | STYLE 2: CANCELLED | STYLE 3: CANCELLED | STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE | STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE | STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2 |
|--|-----------------------|--|---|---|---|
| STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2 | STYLE 8: CANCELLED | STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2 | STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2 | STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2 | STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2 |
| STYLE 13: | STYLE 14: | STYLE 15: | STYLE 16: | STYLE 17: | STYLE 18: |
| PIN 1. ANODE | PIN 1. VREF | PIN 1. ANODE 1 | PIN 1. BASE 1 | PIN 1. BASE 1 | PIN 1. VIN1 |
| 2. N/C | 2. GND | 2. ANODE 2 | 2. EMITTER 2 | 2. EMITTER 1 | 2. VCC |
| 3. COLLECTOR | 3. GND | 3. ANODE 3 | 3. COLLECTOR 2 | 3. COLLECTOR 2 | 3. VOUT2 |
| 4. EMITTER | 4. IOUT | 4. CATHODE 3 | 4. BASE 2 | 4. BASE 2 | 4. VIN2 |
| 5. BASE | 5. VEN | 5. CATHODE 2 | 5. EMITTER 1 | 5. EMITTER 2 | 5. GND |
| 6. CATHODE | 6. VCC | 6. CATHODE 1 | 6. COLLECTOR 1 | 6. COLLECTOR 1 | 6. VOUT1 |
| STYLE 19: | STYLE 20: | STYLE 21: | STYLE 22: | STYLE 23: | STYLE 24: |
| PIN 1. I OUT | PIN 1. COLLECTOR | PIN 1. ANODE 1 | PIN 1. D1 (i) | PIN 1. Vn | PIN 1. CATHODE |
| 2. GND | 2. COLLECTOR | 2. N/C | 2. GND | 2. CH1 | 2. ANODE |
| 3. GND | 3. BASE | 3. ANODE 2 | 3. D2 (i) | 3. Vp | 3. CATHODE |
| 4. V CC | 4. EMITTER | 4. CATHODE 2 | 4. D2 (c) | 4. N/C | 4. CATHODE |
| 5. V EN | 5. COLLECTOR | 5. N/C | 5. VBUS | 5. CH2 | 5. CATHODE |
| 6. V REF | 6. COLLECTOR | 6. CATHODE 1 | 6. D1 (c) | 6. N/C | 6. CATHODE |
| STYLE 25: | STYLE 26: | STYLE 27: | STYLE 28: | STYLE 29: | STYLE 30: |
| PIN 1. BASE 1 | PIN 1. SOURCE 1 | PIN 1. BASE 2 | PIN 1. DRAIN | PIN 1. ANODE | PIN 1. SOURCE 1 |
| 2. CATHODE | 2. GATE 1 | 2. BASE 1 | 2. DRAIN | 2. ANODE | 2. DRAIN 2 |
| 3. COLLECTOR 2 | 3. DRAIN 2 | 3. COLLECTOR 1 | 3. GATE | 3. COLLECTOR | 3. DRAIN 2 |
| 4. BASE 2 | 4. SOURCE 2 | 4. EMITTER 1 | 4. SOURCE | 4. EMITTER | 4. SOURCE 2 |
| 5. EMITTER | 5. GATE 2 | 5. EMITTER 2 | 5. DRAIN | 5. BASE/ANODE | 5. GATE 1 |
| 6. COLLECTOR 1 | 6. DRAIN 1 | 6. COLLECTOR 2 | 6. DRAIN | 6. CATHODE | 6. DRAIN 1 |

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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